

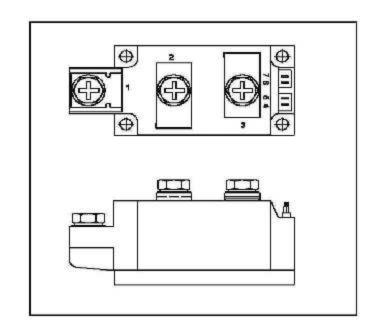
### Ruttonsha International Rectifier Ltd.

### POWER MODULES

# IRK.185 SERIES High Voltage Thyristor/Diode and Thyristor/Thyristor

#### **FEATURES**

- Electrically isolated base plate.
- ❖ 3000 V<sub>RMS</sub> isolating voltage.
- Industrial standard package.
- Simplified mechanical designs, rapid assembly.
- High surge capability.
- Large creepage distances.
- Aluminum Nitride



### DESCRIPTION

These IRK series of Power Modules use power thyristors/ diodes in four basic configurations. The semiconductors are electrically isolated from the metal base, allowing common heatsinks and compact assemblies to be built. They can be interconnected to form single phase or three phase bridges or as AC-switches when modules are connected in anti-parallel.

These modules are intended for general purpose applications such as battery chargers, welders and plating equipment.

#### **MAJOR RATINGS & CHARACTERISTICS**

Parameters		IRK 185	Units	
I <sub>T(AV)</sub> @ 85°C		185	Α	
I <sub>T(RMS)</sub>		290	А	
I <sub>TSM</sub>	@ 50 Hz	7500	А	
I <sup>2</sup> t	@ 50 Hz	280	kA2s	
l²√t		2800	kA²√s	
V <sub>DRM</sub> -V <sub>B</sub>	RM	1500 to 3000	V	
T <sub>J</sub>		-40 to 125	°C	

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## ELECTRICAL SPECIFICATION VOLTAGE RATINGS

Type Number	Voltage Code	V <sub>RRM</sub> / V <sub>DRM</sub> , max. repetitive peak reverse and off-state voltage blocking voltage	V <sub>RSM</sub> , max. non-repetitive peak reverse voltage V	I <sub>рвм</sub> / I <sub>ввм</sub> max. @ 125°C mA
	15	1500 / 1500	1600	50
	17	1700 / 1700	1800	50
	19	1900 / 1900	2000	50
IRK 185	21	2100 / 2100	2200	50
	23	2300 / 2300	2400	50
	25	2500 / 2500	2600	50
	27	2700 J 2700	2800	50
	30	3000 / 3000	3100	50

### **ON-STATE CONDUCTION**

	Parameters	IRK 185	Units	Condition	s			
I <sub>T(AV)</sub>	Max. average on-state current	185	Α	180º cond	180° conduction, half sine wave			
	@ Case temperature	85	°C					
I <sub>T(RMS)</sub>	Max. RMS on-state current	290	Α	as AC switch				
I <sub>TSM</sub>	Max. peak, one cycle on-state, non-repetitive surge current	7500	Α	t = 10ms		Sinusoidall half wave, Initial $T_j = T_j$ max.		
					No voltage			
Pt	Maximum I <sup>2</sup> t for fusing	num l²t for fusing 280 kA²s t = 10ms reapplie	reapplied	Sinusoidal half wave, Initial $T_J = T_J$ max.				
J²v¦t	Maximum l²v't for fusing	2800	kA²√s	t = 0.1 to 10ms. No voltage reapplied.				
V <sub>T(T0)</sub>	Threshold voltage	1.14	٧	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$				
r <sub>t</sub>	On-state slope resistance	0.78	mΩ	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$				
V <sub>TM</sub>	Max. on-state voltage drop	2.6	٧	$I_{TM} = 1000A$ , $T_d = T_J \text{ max.}$ , $180^{\circ}$ conduction AV. power = $V_{T(TO)} \times I_{T(AV)} + r_t \times (I_{T(RMS)})^{\circ}$				
l <sub>H</sub>	Maximum holding current	500	mA	Anode su	Anode supply = 12V, initial $I_T = 30A$ , $T_J = 25^{\circ}C$			
I <sub>L</sub>	Max. latching current	1000	mA	Anode supply = 12V, resistive load = $1\Omega$ , gate pulse : 10V, 100 $\mu$ s, $T_J = 25^{\circ}$ C				

### SWITCING

t <sub>d</sub>	Typical delay time	1.0	1.0	1.0	μs	T <sub>J</sub> = 25°C	Gate current = 1A dlg/ <sub>dl</sub> = 1A/μs
t,	Typical rise time	2.0	2.0	2.0	μs	T <sub>J</sub> = 25°C	Vd = 0.67% V <sub>DRM</sub>
<b>t</b> q	Typical turn-off time		100		μs	l <sub>TM</sub> = 300A Vr = 50V; (	λ; dl/dt = 15Α/μs; T <sub>J</sub> = T <sub>J</sub> max.: dV/dt = 20V/μs; Gate 0V, 100ohm

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### **BLOCKING**

	Parameter	IRK 185		Units Conditions
dv/dt	Maximum critical rate of rise of off-state voltage	500	V/µs	T <sub>J</sub> = 125°C, exponential to 67% rated V <sub>DRM</sub>
BRIM DRIM	Max. peak reverse and off-state leakage current	50	mA	T <sub>J</sub> = 125°C, rated V <sub>DRM</sub> /V <sub>BBM</sub> applied
V <sub>ins</sub>	RMS isolation voltage	3000	٧	50Hz, Circuit to base, all terminal shorted, 25°C, 1Min.

#### TRIGGERING

	Parameter	IRK 185	Units	Conditions			
$P_{\text{GM}}$	Maximum peak gate power	10.0	181	$T_{J} = 125^{\circ}C,$	t <sub>p</sub> ≤ 5ms		
P <sub>G(AV)</sub>	Maximum average gate power	2.0	_ w	T <sub>J</sub> = 125°C, f= 50Hz, d% = 50			
I <sub>GM</sub>	Max. peak positive gate current	3.0	А	$T_{J} = 125^{\circ}C, t_{p} \le 5ms$			
+V <sub>GM</sub>	Max. peak positive gate voltage	20	_ v	T <sub>J</sub> = 125°C,	t < 5me		
-V <sub>GM</sub>	Max. peak negative gate voltage	5.0		1, - 120 0,	t <sub>p</sub> ≤ Sills		
I <sub>GT</sub>	DC gate current required to trigger	200	mA	T <sub>J</sub> = 25°C	Max. required gate trigger/current / voltage are the lowest value which will trigger all units 12V anode-to-cathode		
V <sub>GT</sub>	DC gate voltage required to trigger	2.0	٧	T <sub>J</sub> = 25°C	applied.		
V <sub>GD</sub>	DC gate voltage not to trigger	0.25	V	T <sub>J</sub> = 125°C	Max. gate current / voltage not to trigger the max. value which will not trigger any		
l <sub>GD</sub>	DC gate current not to trigger	10.0	mA	$T_{\rm d} = 125^{\rm o}{\rm C}$	unit with rated V <sub>DRM</sub> anode-to-cathode applied		
di/dt	Maximum critical rate of rise of turned-on current	100	A/μs	$T_{\rm J} = 125^{\rm o}{\rm C},$	$I_{TM}$ =400A ,rated $V_{DRM}$ applied		

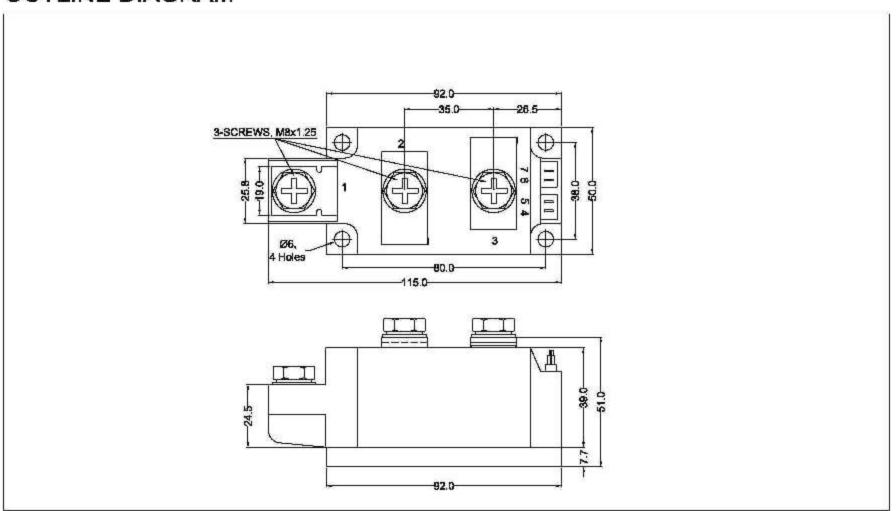
#### THERMAL AND MECHANICAL SPECIFICATION

	Parameter	IRK 185	Units	Conditions	
Tj	Max. operating temperature range	-40 to 125	20		
T <sub>s.g</sub>	Max. storage temperature range	-40 to 130	- °C		
R <sub>thJ-C</sub>	Max. thermal resistance, junction	0.125	K/W	Per Arm	
R <sub>-hJ-C</sub>	to case  Max. thermal resistance, Case to heatsink	0.04	K/W	Per Arm	
Т	Mounting tourque, ±10%	4 to 6 8 to 10	Nm	For Module to heatsink Busbar to Module	
wt	Approximate weight	800	g		
	Case style	MAGN-A-PAK			

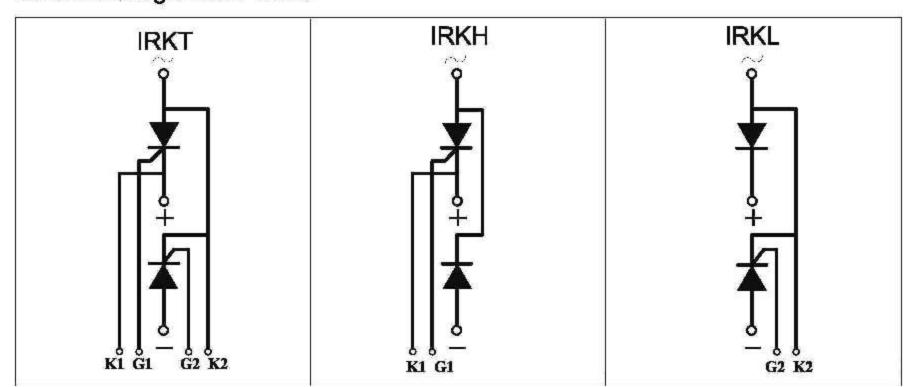
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### **IRK. 185 SERIES**

### **OUTLINE DIAGRAM**



### Circuit Configuration Table



### Ordering Information Table

